#### DATA SHEET



Solid State Relay OCMOS FET

# **PS7212-1A**

### 4-PIN SOP 100 V BREAK DOWN VOLTAGE 1-ch Optical Coupled MOS FET

#### **DESCRIPTION**

The PS7212-1A is a solid state relay containing GaAs LEDs on the light emitting side (input side) and normally open (N.O.) contact MOS FETs on the output side.

It is suitable for analog signal control because of its low offset and high linearity.

#### **FEATURES**

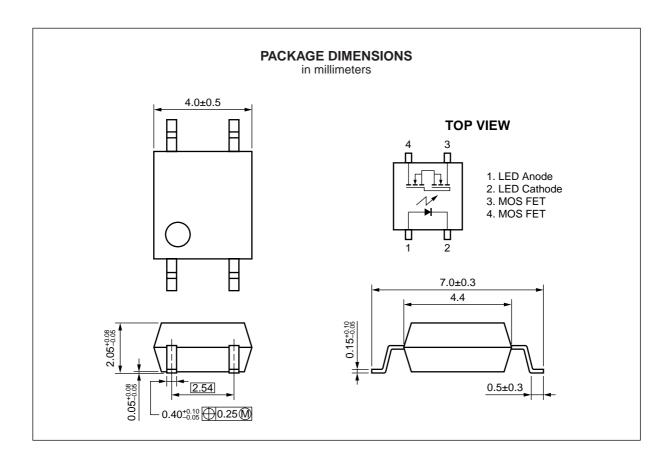
- Small and thin package (4-pin SOP, Height = 2.1 mm)
- 1 channel type (1 a output)
- Low LED operating current (IF = 2 mA)
- · Designed for AC/DC switching line changer
- · Low offset voltage
- Ordering number of taping product: PS7212-1A-E3, E4, F3, F4

#### **APPLICATIONS**

- · Laptop PC, PDA
- Modem card
- · Telephone, FAX
- Measurement equipment

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.





#### **★ ORDERING INFORMATION**

Part Number	Package	Packing Style	Application Part Number*1
PS7212-1A	4-pin SOP	Magazine case 100 pcs	PS7212-1A
PS7212-1A -E3		Embossed Tape 900 pcs/reel	
PS7212-1A -E4			
PS7212-1A -F3		Embossed Tape 3 500 pcs/reel	
PS7212-1A -F4			

<sup>\*1</sup> For the application of the Safety Standard, following part number should be used.

### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	e Forward Current (DC)		50	mA
	Reverse Voltage	VR	5.0	V
	Power Dissipation	PD	50	mW
	Peak Forward Current <sup>⁴1</sup>	IFP	1	Α
MOS FET	Break Down Voltage	VL	100	V
	Continuous Load Current	lι	200	mA
	Pulse Load Current <sup>*2</sup> (AC/DC Connection)	ILP	400	mA
	Power Dissipation	Po	300	mW
Isolation Vo	Isolation Voltage*3		1 500	Vr.m.s.
Total Power Dissipation		Рт	350	mW
Operating Ambient Temperature		TA	-40 to +80	°C
Storage Temperature		T <sub>stg</sub>	-40 to +100	°C

<sup>\*1</sup> PW = 100  $\mu$ s, Duty Cycle = 1 %

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<sup>\*2</sup> PW = 100 ms, 1 shot

<sup>\*3</sup> AC voltage for 1 minute at  $T_A = 25$  °C, RH = 60 % between input and output

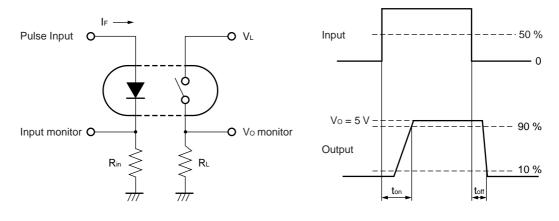
### RECOMMENDED OPERATING CONDITIONS (TA = 25 °C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

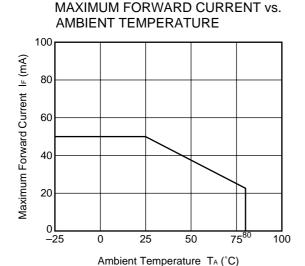
#### **ELECTRICAL CHARACTERISTICS (TA = 25 °C)**

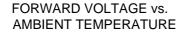
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	lR	V <sub>R</sub> = 5 V			5.0	μΑ
MOS FET	Off-state Leakage Current	Loff	V <sub>D</sub> = 100 V		0.03	1.0	μΑ
	Output Capacitance	Cout	V <sub>D</sub> = 0 V, f = 1 MHz		57		pF
Coupled	LED On-state Current	IFon	IL = 200 mA			2.0	mA
	On-state Resistance	Ron1	IF = 10 mA, IL = 10 mA		3.0	6.0	Ω
		Ron2	$I_F = 10 \text{ mA}, I_L = 200 \text{ mA}, t \le 10 \text{ ms}$				
	Turn-on Time <sup>™</sup>	ton	I <sub>F</sub> = 10 mA, V <sub>O</sub> = 5 V, PW ≥ 10 ms		0.35	1.0	ms
	Turn-off Time <sup>™</sup>	toff			0.08	0.2	
	Isolation Resistance	R <sub>I-O</sub>	Vi-o = 1.0 kVpc	10°			Ω
	Isolation Capacitance	C <sub>I-O</sub>	V = 0 V, f = 1 MHz		0.5		pF

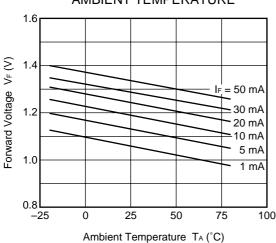
#### ★ \*1 Test Circuit for Switching Time



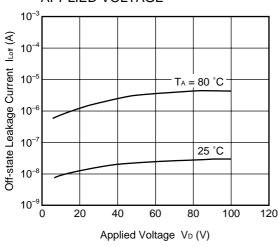
#### **★** TYPICAL CHARACTERISTICS (TA = 25 °C, unless otherwise specified)



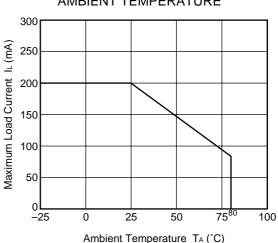




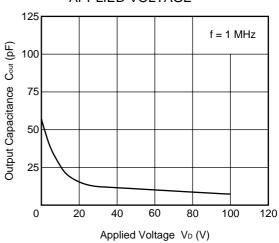
### OFF-STATE LEAKAGE CURRENT vs. APPLIED VOLTAGE



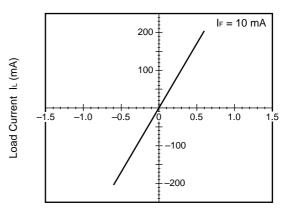
## MAXIMUM LOAD CURRENT vs. AMBIENT TEMPERATURE



# OUTPUT CAPACITANCE vs. APPLIED VOLTAGE



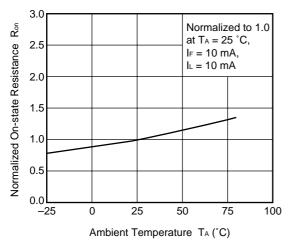
#### LOAD CURRENT vs. LOAD VOLTAGE



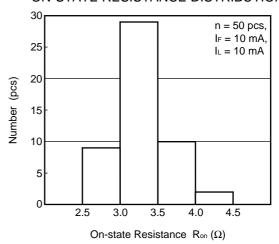
Load Voltage V<sub>L</sub> (V)



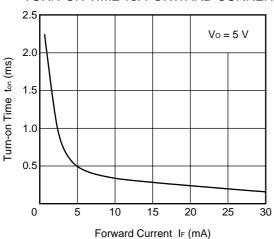
# NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



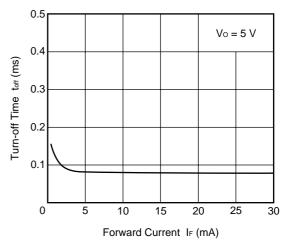
#### ON-STATE RESISTANCE DISTRIBUTION



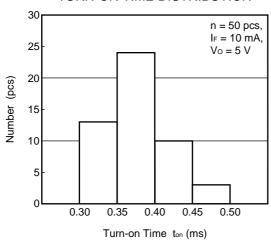
#### TURN-ON TIME vs. FORWARD CURRENT



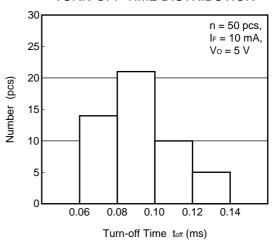
TURN-OFF TIME vs. FORWARD CURRENT



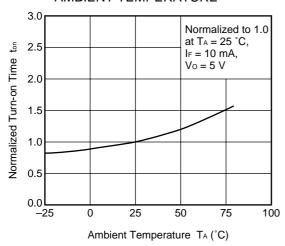
#### TURN-ON TIME DISTRIBUTION



#### TURN-OFF TIME DISTRIBUTION

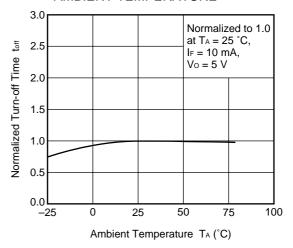


# NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE

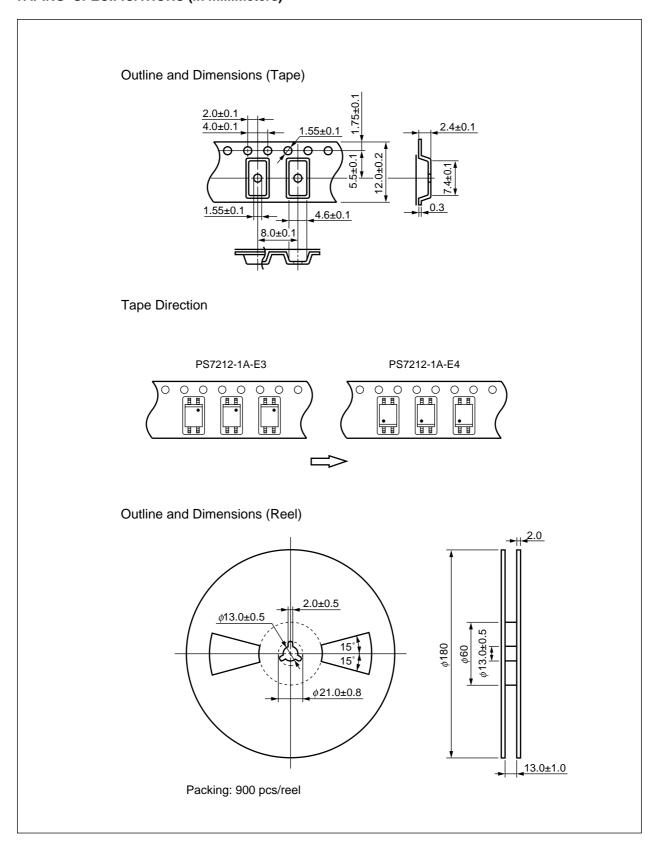


**Remark** The graphs indicate nominal characteristics.

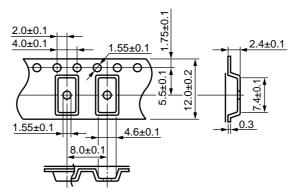
# NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE



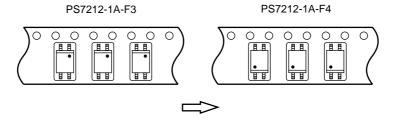
### **★ TAPING SPECIFICATIONS (in millimeters)**



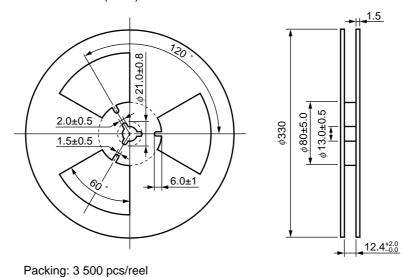
#### Outline and Dimensions (Tape)



### **Tape Direction**



#### Outline and Dimensions (Reel)





#### \* RECOMMENDED SOLDERING CONDITIONS

#### (1) Infrared reflow soldering

• Peak reflow temperature 235 °C (package surface temperature)

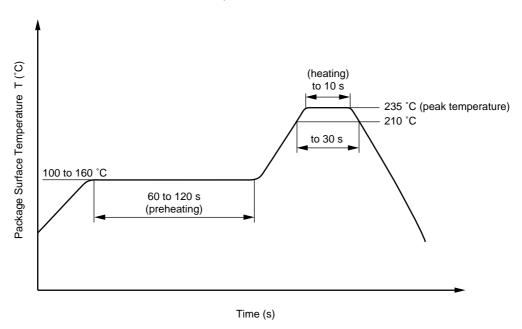
• Time of temperature higher than 210 °C 30 seconds or less

• Number of reflows Two

Flux
 Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt % is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



#### (2) Dip soldering

• Temperature 260 °C or below (molten solder temperature)

• Time 10 seconds or less

• Number of times One

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of

0.2 Wt % is recommended.)

#### (3) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

NEC PS7212-1A

[MEMO]

#### **CAUTION**

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.

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